

**IN THE U.S. PATENT AND TRADEMARK OFFICE**

In re application of

Tomoko HONGO et al.

Conf. 3419

Application No. 10/564,837

Group 1796

Filed April 17, 2006

Examiner Chun Cheng Wang

METAL COLLOID SOLUTION

**AMENDMENT**

Assistant Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

April 27, 2009

Sir:

In response to the Office Action mailed November 25, 2008, for which the period for response has been extended two months, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 11 of this paper.

An **Appendix** is attached following the signature page of this paper.